

Soft Switching Series

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit	
Characteristic				1	
IGBT thermal resistance,	$R_{\rm thJC}$		0.36	K/W	
junction – case					
Diode thermal resistance,	R _{thJCD}		0.36		
junction – case					
Thermal resistance,	R _{thJA}		40		
junction – ambient					

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\rm GE}$ =0V, $I_{\rm C}$ =500 μ A	1000	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE}$ = 15V, $I_{\rm C}$ =30A				
		<i>T</i> _j =25°C	-	1.5	1.7	
		<i>T</i> _j =150°C	-	1.7	-	
		<i>T</i> _j =175°C	-	1.75	-	
Diode forward voltage	V _F	V _{GE} =0V, <i>I</i> _F =30A				1
		<i>T</i> _j =25°C	-	1.5	1.7	
		<i>T</i> _j =150°C	-	1.65	-	
		<i>T</i> _j =175°C	-	1.7	-	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C} = 700 \mu {\rm A}, V_{\rm CE} = V_{\rm GE}$	5.1	5.8	6.4	
Zero gate voltage collector current	I _{CES}	V _{CE} =1000V, V _{GE} =0V				μA
		<i>T</i> _j =25°C	-	-	5	
		<i>T</i> _j =175°C	-	-	2500	
Gate-emitter leakage current	I _{GES}	$V_{\rm CE}$ =0V, $V_{\rm GE}$ =20V	-	-	600	nA
Transconductance	$g_{ m fs}$	V _{CE} =20V, <i>I</i> _C =30A	-	56	-	S

Dynamic Characteristic

·			-			
Input capacitance	Ciss	V _{CE} =25V,	-	2791	-	pF
Output capacitance	Coss	V _{GE} =0V,	-	82	-	
Reverse transfer capacitance	Crss	f=1MHz	-	78	-	
Gate charge	Q _{Gate}	V _{CC} =800V, <i>I</i> _C =30A	-	209	-	nC
		V _{GE} =15V				
Internal emitter inductance	LE		-	13	-	nH
measured 5mm (0.197 in.) from case						



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Switching Characteristic, Inductive Load, at T_j =25 °C

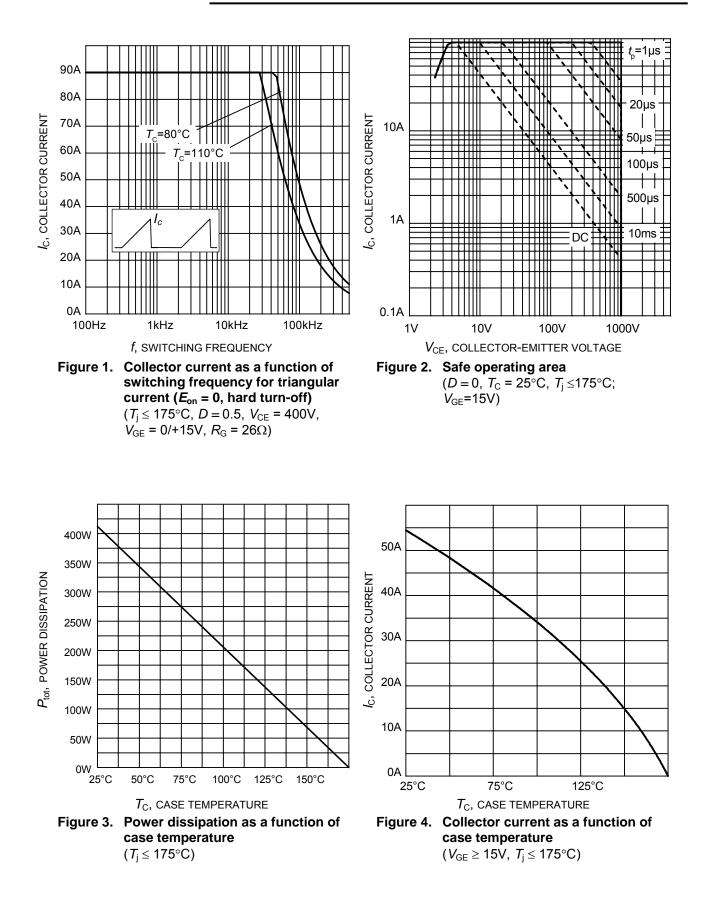
Parameter	Cumhal	Conditions	Value			11
	Symbol		min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-off delay time	$t_{d(off)}$	<i>T</i> _j =25°C,	-	846	-	
Fall time	t _f	V _{CC} =600V, <i>I</i> _C =30A,	-	33.3		
Turn-on energy	Eon	V _{GE} =0/15V,	-	-		mJ
Turn-off energy	E _{off}	$R_{\rm G}$ =26 Ω ,	-	2.1		
Total switching energy	Ets		-	-	-	

Switching Characteristic, Inductive Load, at Tj=175 °C

Parameter	Symbol	Conditions	Value			Unit
	Symbol		min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-off delay time	$t_{d(off)}$	<i>T</i> _j =175°C	-	948	-	
Fall time	t _f	V _{cc} =600V,	-	40.4	-	
Turn-on energy	Eon	I _C =30A,	-	-	-	mJ
Turn-off energy	E _{off}	V _{GE} =0/15V,	-	2.86	-	
Total switching energy	Ets	$R_{\rm G}$ = 26 Ω	-	-	-	

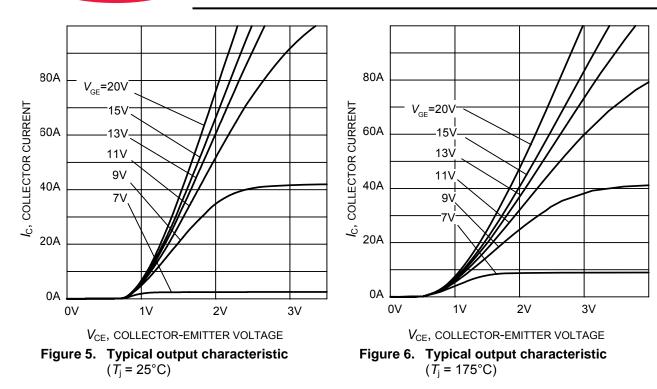


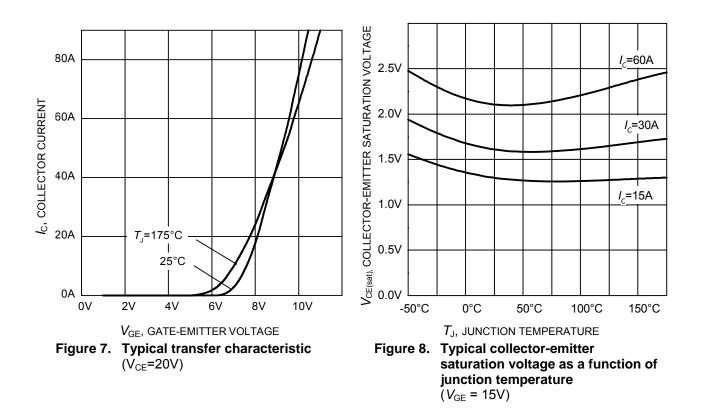
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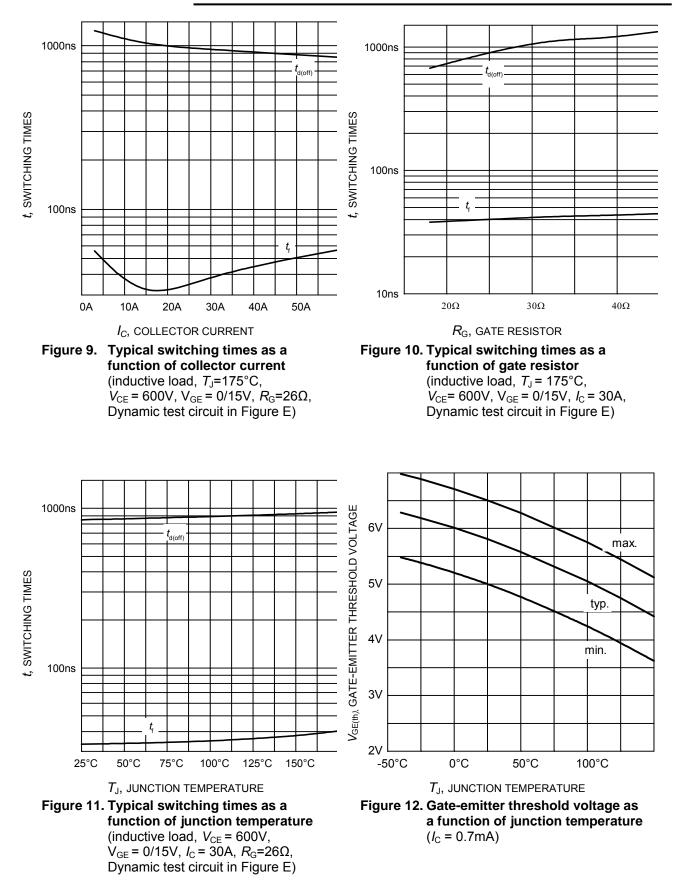
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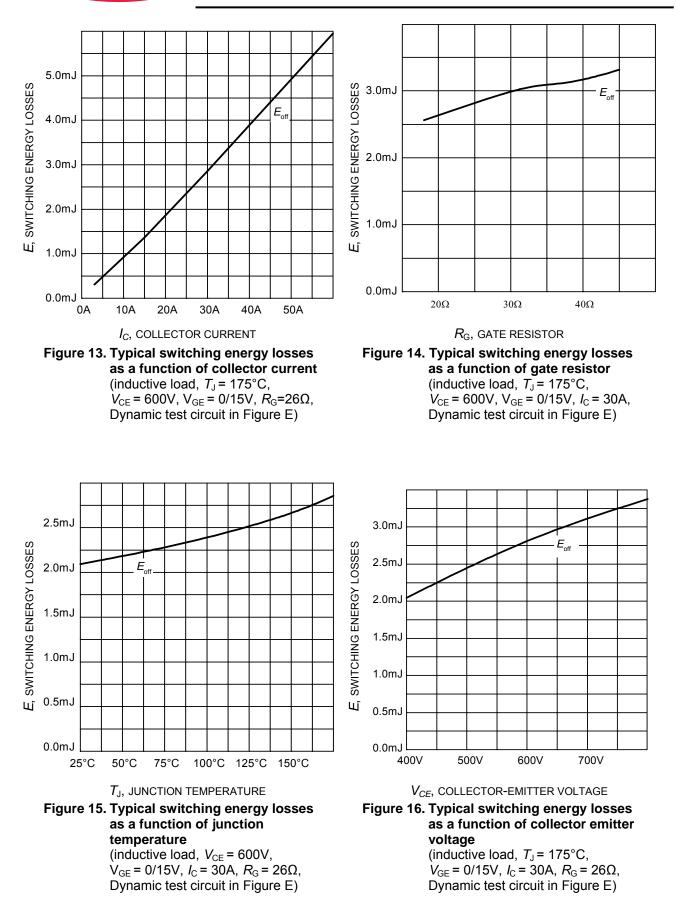


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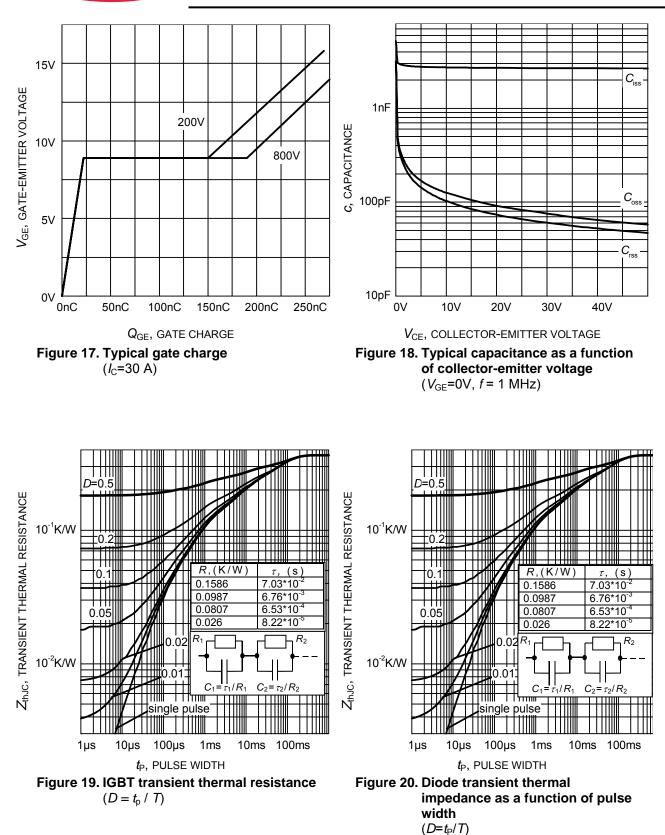
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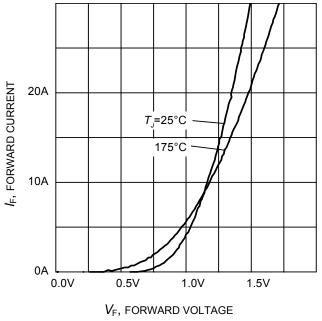


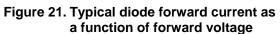
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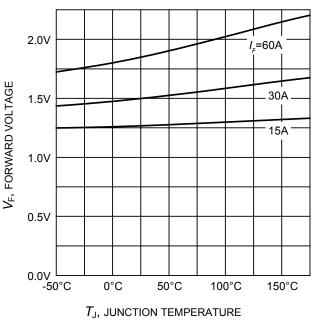


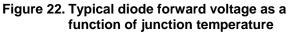


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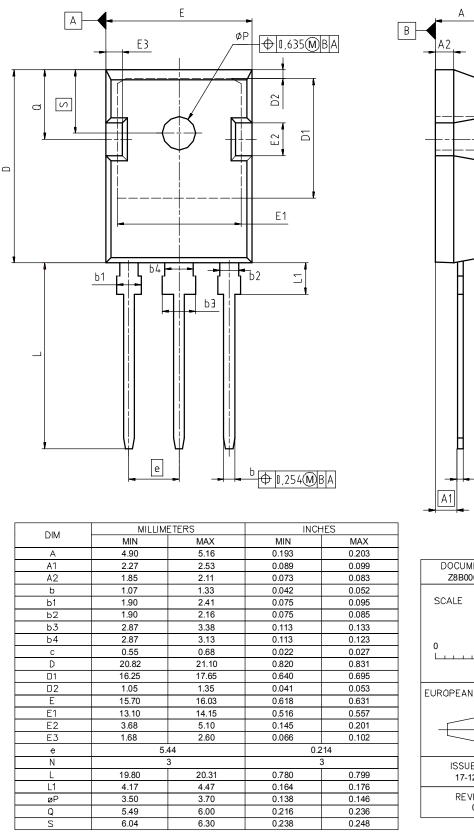




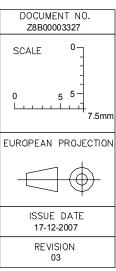


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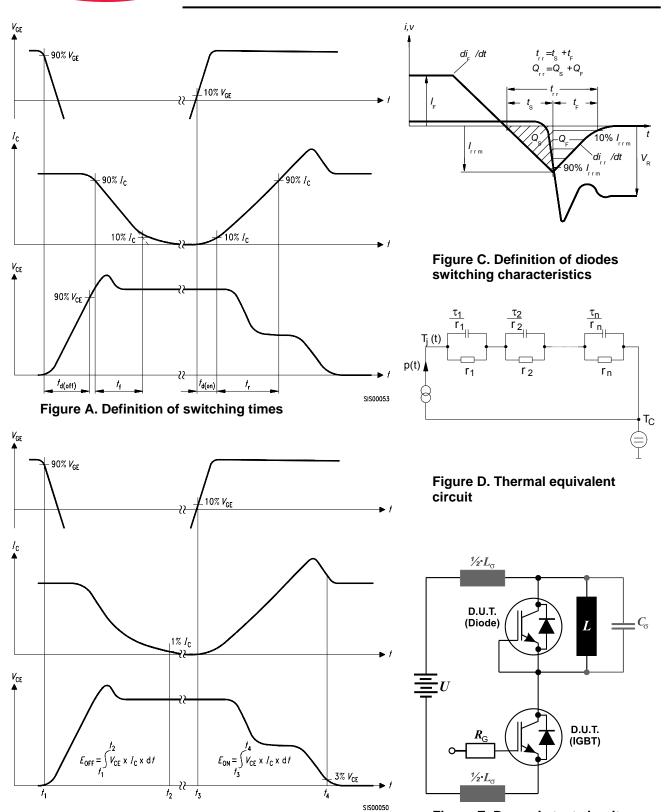


Figure E. Dynamic test circuit

Figure B. Definition of switching losses



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